

NCP786A

Linear Regulator - Wide Input Voltage Range, Ultra-Low Iq, High PSRR, Adjustable Output Voltage

10 mA

The NCP786A is high-performance linear regulator, offering a very wide operating input voltage range of up to 450 V DC, with an output current of up to 10 mA. Ideal for high input voltage applications such as industrial and home metering, home appliances. The NCP786A family offers $\pm 3\%$ initial accuracy, extremely high-power supply rejection ratio and ultra-low quiescent current. The NCP786A family is optimized for high-voltage line and load transients, making them ideal for harsh environment applications. The output voltage can be set by resistor divider in range from 1.27 V up to 15 V. DFN6 5x6 package with high allowable power dissipation keep small footprint at space sensitive applications.

Features

- Wide Input Voltage Range:
DC: Up to 450 V
AC: 85 V to 260 V (half-wave rectifier and 4.7 μ F capacitor)
- 10 mA Guaranteed Output Current
- Ultra Low Quiescent Current: Typ. 10 μ A ($V_{OUT} \leq 15$ V)
- $\pm 5\%$ Accuracy Over Full Load, Line and Temperature Variations
- Ultra-high PSRR: 70 dB at 60 Hz, 90 dB at 100 kHz
- Stable with Ceramic Output Capacitor 2.2 μ F MLCC
- Thermal Shutdown and Current Limit Protection
- Available in DFN6 5x6 Package
- This is a Pb-Free Device

Typical Applications

- Industrial Applications, Home Appliances
- Home Metering / Network Application
- Off-line Power Supplies



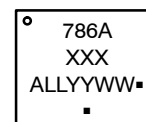
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MARKING DIAGRAM



DFN6 5x6
ST SUFFIX
CASE 506DV



(Top View)

786A = Specific Device Marking
XXX = Voltage Version
(see page 7)

A = Assembly Location

LL = Wafer Lot

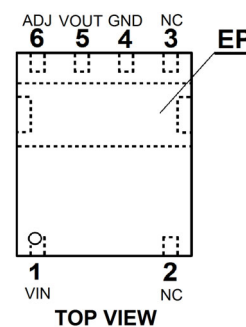
YY = Year

WW = Work Week

▪ = Pb-Free Package

(Note: Microdot may be in either location)

PIN CONNECTIONS



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

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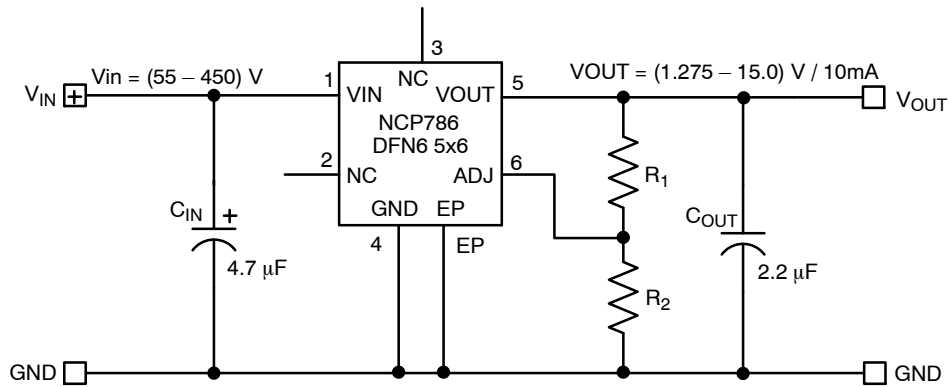


Figure 1. Typical Applications

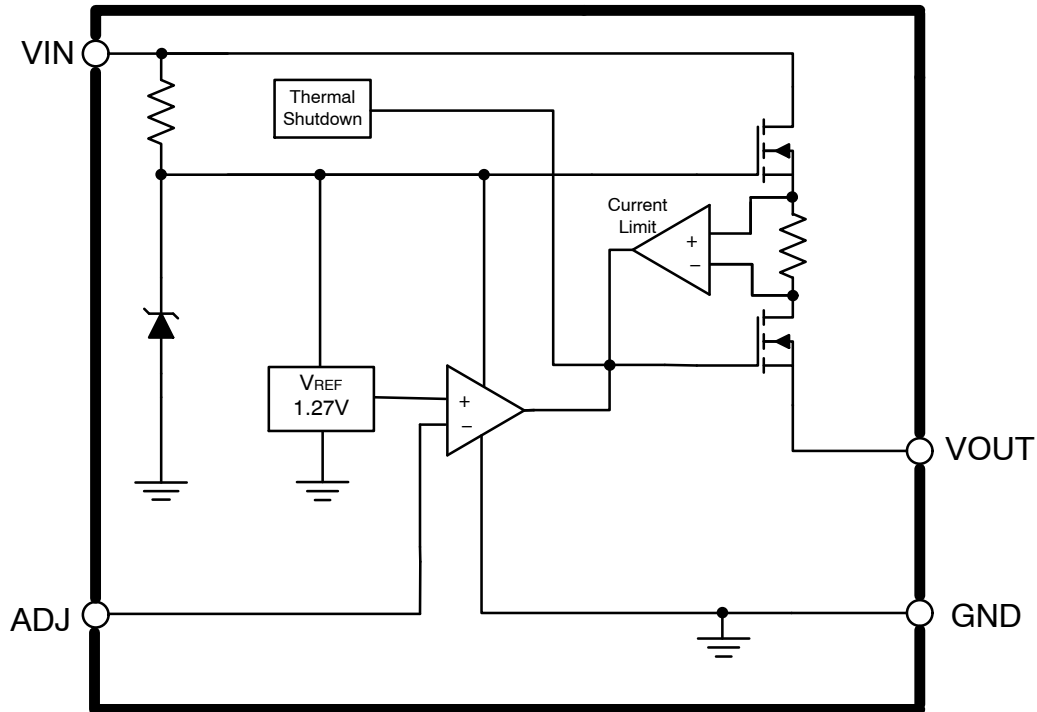


Figure 2. Simplified Internal Block Diagram

Table 1. PIN FUNCTION DESCRIPTION

| Pin No. | Pin Name | Description |
|---------|----------|--|
| 1 | VIN | Supply Voltage Input. Connect 4.7 μ F capacitor from VIN to GND. |
| 2 | NC | Not connected. |
| 3 | NC | Not connected. |
| 4 | GND | Ground connection. |
| 5 | VOUT | Regulator Output. Connect 2.2 μ F or higher MLCC capacitor from VOUT to GND. |
| 6 | ADJ | ADJ pin for output voltage setting via resistors divider. |
| EP | EP | EP should be connected to GND potential. |

Table 2. ABSOLUTE MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|------------------------------|--------------|-------------|--------------|
| Input Voltage (Note 1) | V_{IN} | -0.3 to 700 | V |
| Output Voltage | V_{OUT} | -0.3 to 18 | V |
| Maximum Junction Temperature | $T_{J(MAX)}$ | 125 | $^{\circ}$ C |

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Table 2. ABSOLUTE MAXIMUM RATINGS

| | | | |
|---|-------------|------------|----|
| Storage Temperature | T_{STG} | -55 to 150 | °C |
| ESD Capability, Human Body Model (All pins except HV pin no.1) (Note 2) | ESD_{HBM} | 2000 | V |
| ESD Capability, Machine Model (Note 2) | ESD_{MM} | 200 | V |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Peak 650 V max 1 ms non repeated for 1 s
2. This device series incorporates ESD protection and is tested by the following methods:
 - ESD Human Body Model tested per AEC-Q100-002 (EIA/JESD22-A114)
 - ESD Machine Model tested per AEC-Q100-003 (EIA/JESD22-A115)
 - Latch-up Current Maximum Rating tested per JEDEC standard: JESD78.

Table 3. THERMAL CHARACTERISTICS

| Rating | Symbol | Value | Unit |
|---|-----------------|-------|------|
| Thermal Characteristics, DFN6 Thermal Resistance, Junction-to-Air JEDEC 51.3, One side, 600 sq mm PCB | $R_{\theta JA}$ | 82 | °C/W |

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Table 4. ELECTRICAL CHARACTERISTICS NCP786A Adj. ($-40^{\circ}\text{C} \leq T_J \leq 85^{\circ}\text{C}$; $V_{IN} = 340\text{ V}$; $I_{OUT} = 100\ \mu\text{A}$, $C_{IN} = 4.7\ \mu\text{F}$, $C_{OUT} = 10\ \mu\text{F}$, unless otherwise noted. Typical values are at $T_J = +25^{\circ}\text{C}$.) (Note 3)

| Parameter | Test Conditions | Symbol | Min | Typ | Max | Unit |
|---------------------------------------|--|------------------------------|------|-------|------|--------------------|
| Operating Input Voltage DC | | V_{IN} | 55 | | 450 | V |
| Maximum output voltage | $-40^{\circ}\text{C} \leq T_J \leq 85^{\circ}\text{C}$, $I_{OUT} = 100\ \mu\text{A}$, $55\text{ V} \leq V_{IN} \leq 450\text{ V}$ | V_{OUTMAX} | | 15 | | V |
| Reference Voltage Accuracy | $T_J = 25^{\circ}\text{C}$, $I_{OUT} = 100\ \mu\text{A}$, $55\text{ V} \leq V_{IN} \leq 450\text{ V}$ | V_{REF} | -3% | 1.275 | +3% | V |
| | $-40^{\circ}\text{C} \leq T_J \leq 85^{\circ}\text{C}$, $I_{OUT} = 100\ \mu\text{A}$, $55\text{ V} \leq V_{IN} \leq 450\text{ V}$ | V_{REF} | -5% | 1.275 | +5% | V |
| Line Regulation | $V_{IN} = 55\text{ V to } 450\text{ V}$, $I_{OUT} = 100\ \mu\text{A}$ | Reg_{LINE} | -0.5 | 0.1 | +0.5 | % |
| Load Regulation | $I_{OUT} = 100\ \mu\text{A to } 10\text{ mA}$, $V_{IN} = 55\text{ V}$ | Reg_{LOAD} | -1.0 | 0.7 | +1.0 | % |
| Maximum Output Current | $55\text{ V} \leq V_{IN} \leq 450\text{ V}$, (Note 4) | I_{OUT} | 11 | | | mA |
| Quiescent Current | $I_{OUT} = 0$, $55\text{ V} \leq V_{IN} \leq 450\text{ V}$ | I_{GND} | | 10 | 15 | μA |
| Ground current | $55\text{ V} \leq V_{IN} \leq 450\text{ V}$, (Note 4) $0 < I_{OUT} \leq 10\text{ mA}$ | | | | 25 | μA |
| ADJ Pin current | | | | 150 | | nA |
| Power Supply Rejection Ratio | $V_{IN} = 340\text{ VDC} + 1\text{ Vpp modulation}$, $I_{OUT} = 100\ \mu\text{A}$ | $f = 1\text{ kHz}$ $PSRR$ | | 65 | | dB |
| Noise | $f = 10\text{ kHz to } 1\text{ MHz}$ $V_{IN} = 340\text{ VDC}$, $I_{OUT} = 1\text{ mA}$, $C_{OUT} = 10\ \mu\text{F}$ | V_{NOISE} | | 150 | | μVrms |
| Thermal Shutdown Temperature (Note 5) | Temperature increasing from $T_J = +25^{\circ}\text{C}$ | T_{SD} | | 145 | | $^{\circ}\text{C}$ |
| Thermal Shutdown Hysteresis (Note 5) | Temperature falling from T_{SD} | T_{SDH} | - | 10 | - | $^{\circ}\text{C}$ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at $T_J = T_A = 25^{\circ}\text{C}$. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
4. Respect to Safe Operating Area
5. Guaranteed by design

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TYPICAL CHARACTERISTICS

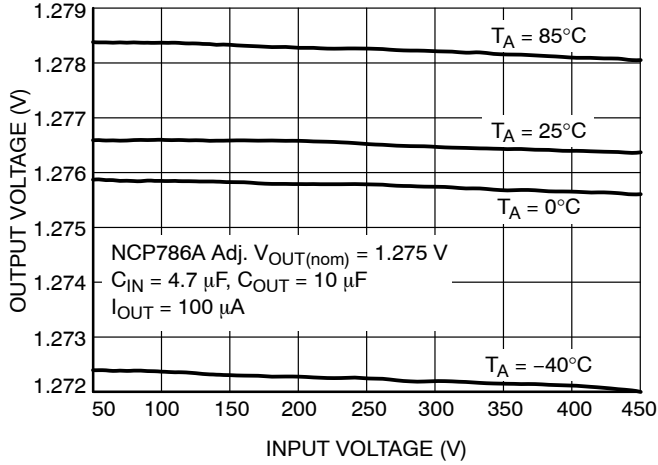


Figure 3. Output Voltage vs. Input Voltage

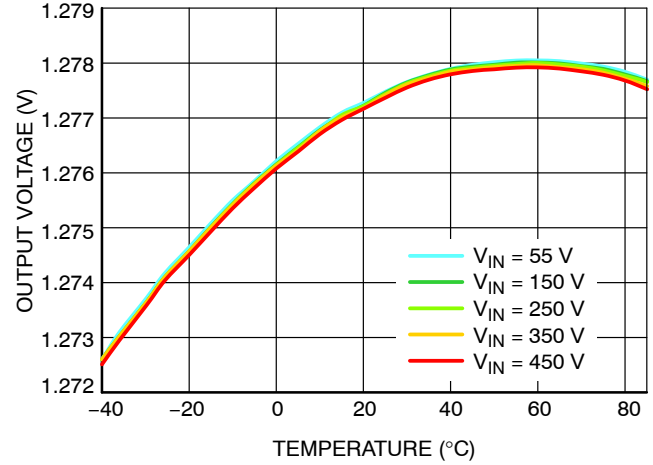


Figure 4. Output Voltage vs. Temperature

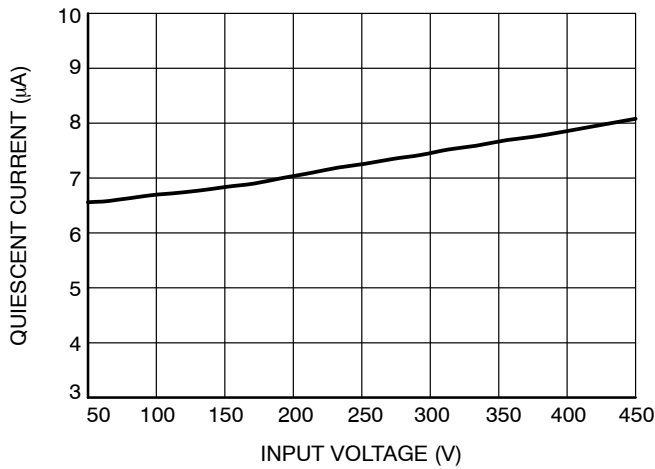


Figure 5. Quiescent Current vs. Input Voltage

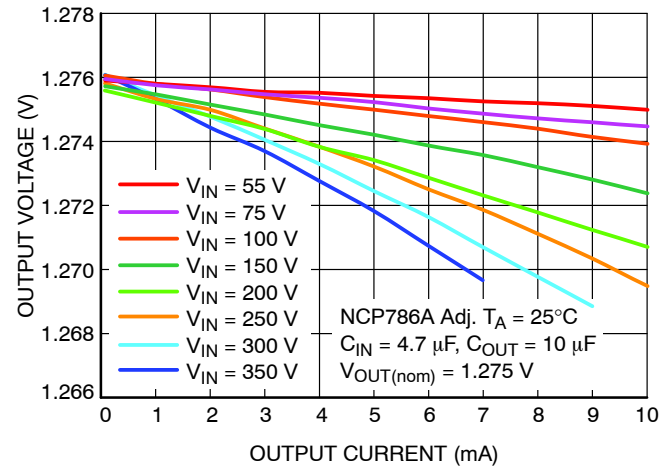


Figure 6. Output Voltage vs. Output Current

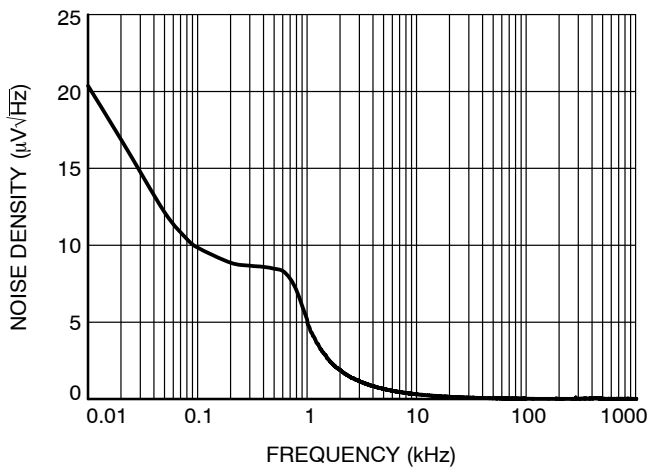


Figure 7. Noise Density vs. Frequency

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APPLICATION INFORMATION

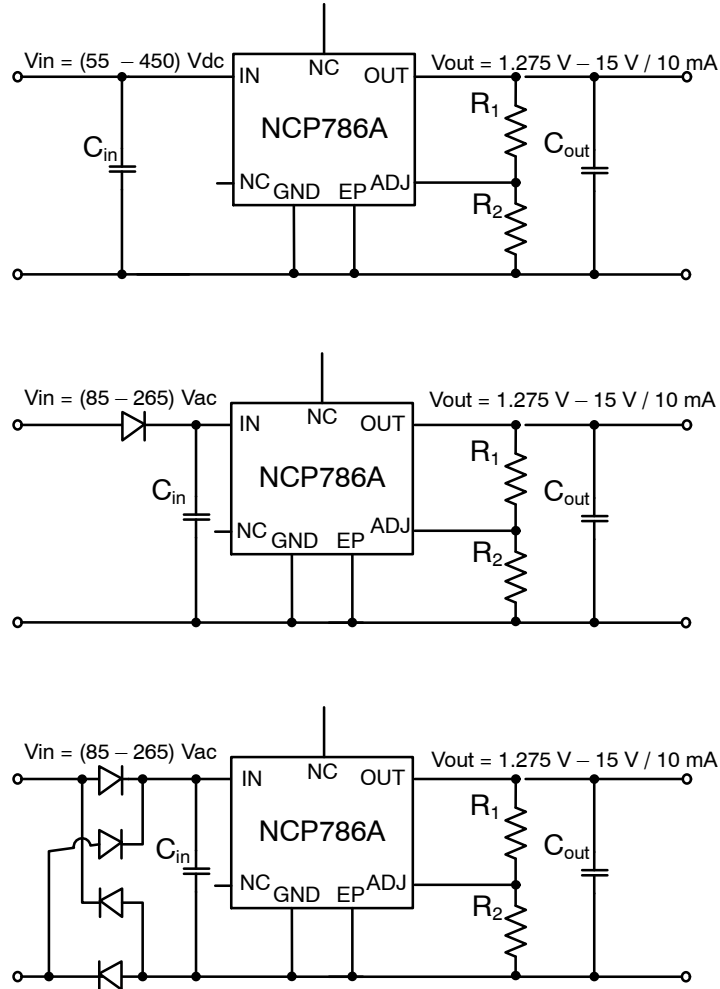


Figure 8. Typical Application Schematics

Input Decoupling (C1)

A 4.7 μF capacitor either ceramic or electrolytic is recommended and should be connected close to the input pin of NCP786A. Higher value 4.7 μF is necessary to keep the input voltage above the required minimum input voltage at full load for AC voltage as low as 85 V with half wave rectifier. The capacitor 2.2 μF or 1 μF could be acceptable for DC input voltage or AC input voltage 235 V $\pm 20\%$. There must be assured minimum Input Voltage more than 55 V at input pin of NCP786A regulator in order to keep stable desired output voltage with guaranteed parameters.

Output Decoupling (C2)

The NCP786A Regulator does not require any specific Equivalent Series Resistance (ESR). Thus capacitors exhibiting ESRs ranging from a few $\text{m}\Omega$ up to 0.5 Ω can be used safely. The minimum decoupling value is 2.2 μF . The regulator accepts ceramic chip capacitors as well as tantalum devices or low ESR electrolytic capacitors. Larger values improve noise rejection and especially load transient response.

Layout Recommendations

Please be sure that the V_{IN} and GND lines are sufficiently wide. When the impedance of these lines is high, there is a chance to pick up noise or to cause the malfunction of regulator.

Set external components, especially the output capacitor, as close as possible to the circuit, and make leads as short as possible.

Thermal

As power across the NCP786A increases, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design layout and used package. Mounting pad configuration on the PCB, the board material, and also the ambient temperature affect the rate of temperature rise for the part. This is stating that when the NCP786A has good thermal conductivity through the PCB, the junction temperature will be relatively low with high power dissipation applications.

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Output Voltage

The output voltage can be set by using a resistor divider as shown in Figure 1 in range from 1.275 V up to 15 V. The appropriate resistor divider can be found by solving the equation below.

$$V_{OUT} = 1.275 \times \left(1 + \frac{R1}{R2}\right) + (I_{ADJ} \times R1) \quad (\text{eq. 1})$$

The recommended current through the resistor divider is from 1 μ A to 3 μ A in order to keep negligible ADJ pin consumption. In this case we can simplify Equation 1 to:

$$V_{OUT} = 1.275 \times \left(1 + \frac{R1}{R2}\right) \quad (\text{eq. 2})$$

ORDERING INFORMATION

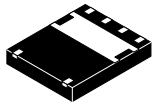
| Part Number | Output Voltage | Marking | Package | Shipping [†] |
|-----------------|----------------|---------|-----------------------|-----------------------|
| NCP786AMNADJTBG | Adjustable | ADJ | DFN6 5x6 (Pb-Free) | 1000 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

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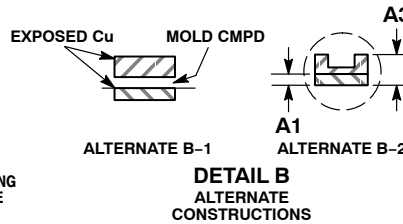
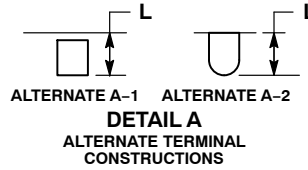
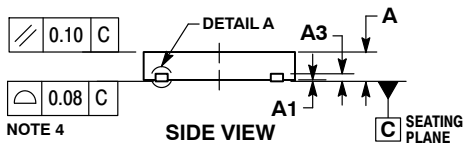
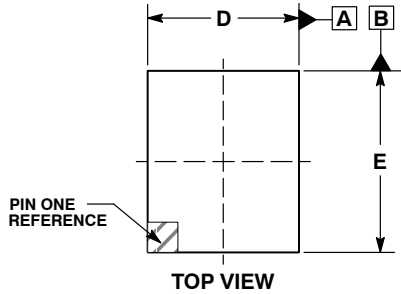
SCALE 2:1

DFN6 5x6, 1.27P

CASE 506DV

ISSUE O

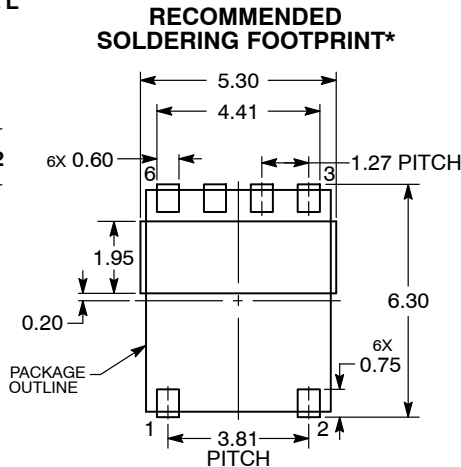
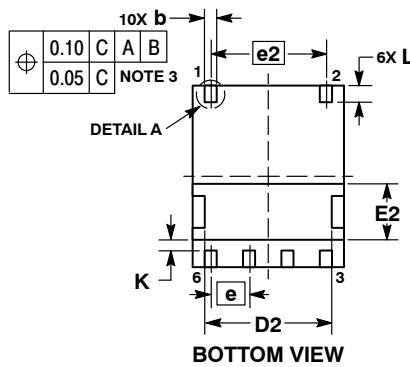
DATE 12 OCT 2016



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.20 AND 0.25 MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
5. FOR DEVICE OPN CONTAINING W OPTION, DETAIL B ALTERNATE B-1 AND DETAIL A ALTERNATE A-1 CONSTRUCTIONS ARE NOT APPLICABLE.

| DIM | MILLIMETERS | | |
|-----|-------------|------|------|
| | MIN | NOM | MAX |
| A | 0.80 | 0.90 | 1.00 |
| A1 | --- | --- | 0.05 |
| A3 | 0.20 REF | | |
| b | 0.30 | 0.40 | 0.50 |
| D | 4.90 | 5.00 | 5.10 |
| D2 | 4.10 | 4.20 | 4.30 |
| E | 5.90 | 6.00 | 6.10 |
| E2 | 1.75 | 1.85 | 1.95 |
| e | 1.27 BSC | | |
| e2 | 3.81 BSC | | |
| K | 0.25 | --- | --- |
| L | 0.45 | 0.55 | 0.65 |



DIMENSIONS: MILLIMETERS

GENERIC MARKING DIAGRAM*



- A = Assembly Location
- LL = Wafer Lot
- YY = Year
- WW = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

| | | |
|------------------|-----------------|--|
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| DESCRIPTION: | DFN6 5X6, 1.27P | PAGE 1 OF 1 |

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